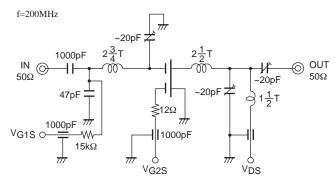
Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit	
Parameter	Symbol Conditions		min	typ	max	UIIIL	
Drain-to-Source Voltage	VDS	V _{G1} S=0V, V _{G2} S=0V, I _D S=100μA	15			V	
Gate1-to-Source Cutoff Voltage	V _{G1S} (off)	V _{DS} =6V, V _{G2S} =4V, I _D =100μA	0	0.7	1.3	V	
Gate2-to-Source Cutoff Voltage	V _{G2S} (off)	V _{DS} =6V, V _{G1S} =3V, I _D =100μA	0.1	0.9	1.6	V	
Gate1-to-Source Leakage Current	IG1SS	V _{G1S} =±6V, V _{G2S} =V _{DS} =0V			±50	nA	
Gate2-to-Source Leakage Current	IG2SS	VG2S=±6V, VG1S=VDS=0V			±50	nA	
Zero-Gate Voltage Drain Current	IDSX	V _{DS} =6V, V _{G1S} =1.5V, V _{G2S} =4V	5.0*		24.0*	mA	
Forward Transfer Admittance	yfs	V _{DS} =6V, I _D =10mA, V _{G2S} =4V, f=1kHz		17		mS	
Input Capacitance	Ciss	VDS=6V, VG1S=0V, VG2S=4V, f=1MHz		2.5		pF	
Reverse Transfer Capacitance	Crss	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\		0.015	0.03	pF	
Power Gain	PG	V _{DS} =6V, I _D =10mA, V _{G2S} =4V, f=200MHz	20	23		dB	
Noise Figure	NF	V _{DS} =6V, I _D =10mA, V _{G2S} =4V, f=200MHz		1.1	2.2	dB	

* : The 3SK264 is classified by $I_{\mbox{DSX}}$ as follows : (unit : mA)

Rank	5	6
IDSX	5.0 to 12.0	10.0 to 24.0

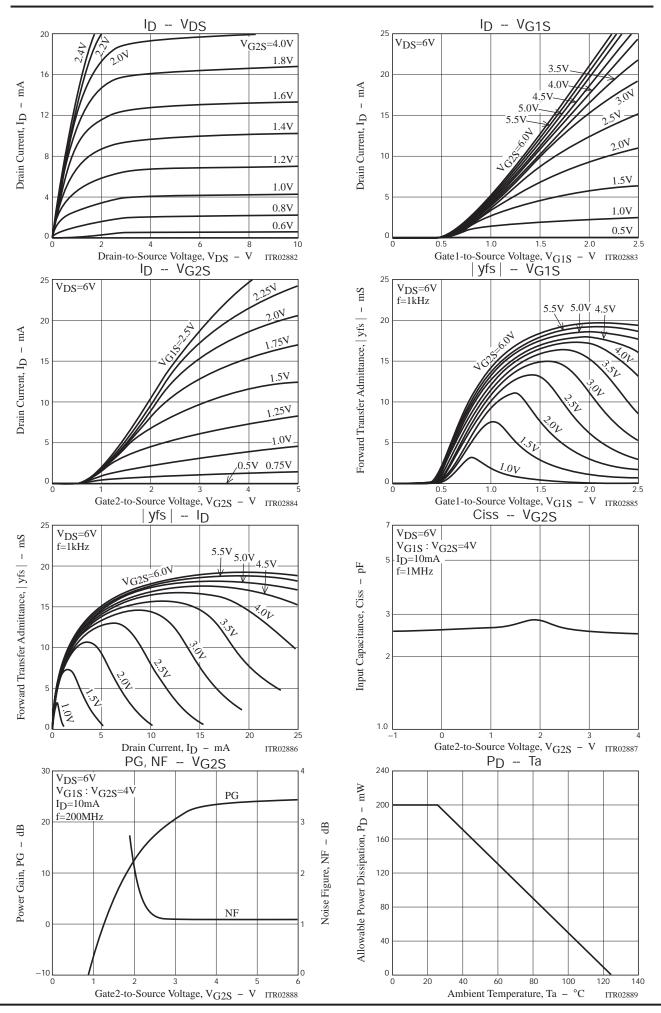
PG, NF Specified Test Circult



L: 1mmØ enamel wire 10mmØ

Ordering Information

Device	Package	Shipping	memo
3SK264-5-TG-E	CP4	3,000pcs./reel	Pb Free



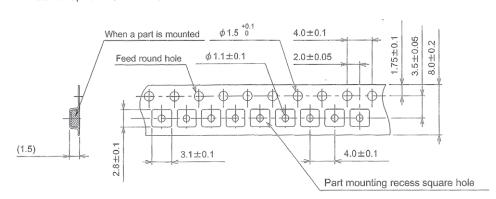
Embossed Taping Specification

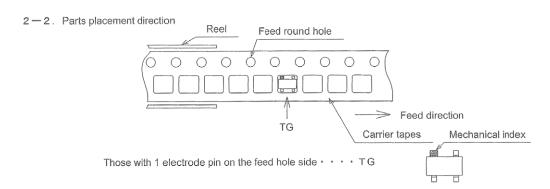
3SK264-5-TG-E

	Carrier tape	Maximum Number of devices contained (pcs.)		ber of d (pcs.)	Packing format		
Outline name	Type number	Reel	Inner box	Outer box	Inner box BOX (C-1)	Outer box BOX (A-7)	
CP4	CP4	3,000	15,000	90,000	5 reels contained Dimensions:mm(external) 1 8 3 × 7 2 × 1 8 5	6 inner boxes contained Dimensions:mm(external) 4 4 0 × 1 9 5 × 2 1 0	

2. Taping structure

2-1. Carrier tape size (Unit: mm)



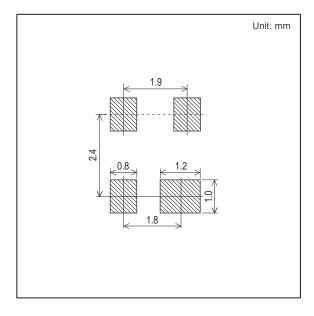


Outline Drawing

3SK264-5-TG-E

Mass (g) Unit 0.013 For reference mm 2. 9±0. 15 0. 4^{+0. 1}_{-0. 05} 0. 1^{+0. 1} 0. 5+0. 25 3 1. 5±0. 15 2. 5±0. 2 0. 6^{+0. 1} 2 0.95 0.85 0. 3±0.1 1. 1±0.15 0.1 \$ *1:Lot indication

Land Pattern Example



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